



6NM120

Preliminary

Power MOSFET

6.0A, 1200V N-CHANNEL SUPER-JUNCTION MOSFET

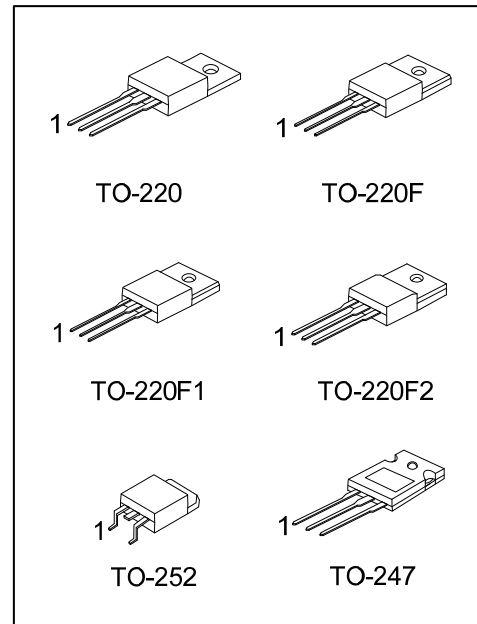
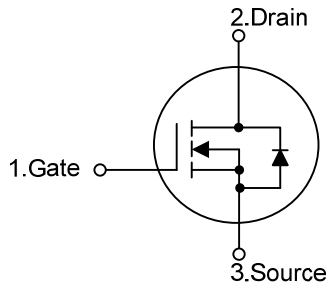
■ DESCRIPTION

The UTC **6NM120** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)} \leq 1.9 \Omega @ V_{GS}=10V, I_D=3.0A$
- * High Switching Speed

■ SYMBOL



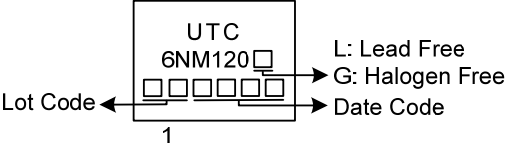
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
6NM120L-TA3-T	6NM120G-TA3-T	TO-220	G	D	S	Tube
6NM120L-TF1-T	6NM120G-TF1-T	TO-220F1	G	D	S	Tube
6NM120L-TF2-T	6NM120G-TF2-T	TO-220F2	G	D	S	Tube
6NM120L-TF3-T	6NM120G-TF3-T	TO-220F	G	D	S	Tube
6NM120L-T47-T	6NM120G-T47-T	TO-247	G	D	S	Tube
6NM120L-TN3-R	6NM120G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>6NM120G-TA3-T</p> <p>(1) Packing Type</p> <p>(2) Package Type</p> <p>(3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2 TF3: TO-220F, T47: TO-247, TN3: TO-252</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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MARKING



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	1200	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	Continuous	I_D	6	A
	Pulsed	I_{DM}	12	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	100	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.9	V/ns
Power Dissipation	TO-220	P_D	70	W
	TO-220F TO-220F1 TO-220F2		27	W
	TO-247		90	W
	TO-252		38	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 100\text{mH}$, $I_{AS} = 1.41\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\ \Omega$ Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD} \leq 6.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ TO-220F TO-220F1 TO-220F2	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-247		40	$^{\circ}\text{C}/\text{W}$
	TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220	θ_{JC}	1.79	$^{\circ}\text{C}/\text{W}$
	TO-220F TO-220F1 TO-220F2		4.62	$^{\circ}\text{C}/\text{W}$
	TO-247		1.39	$^{\circ}\text{C}/\text{W}$
	TO-252		3.29(Note)	$^{\circ}\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

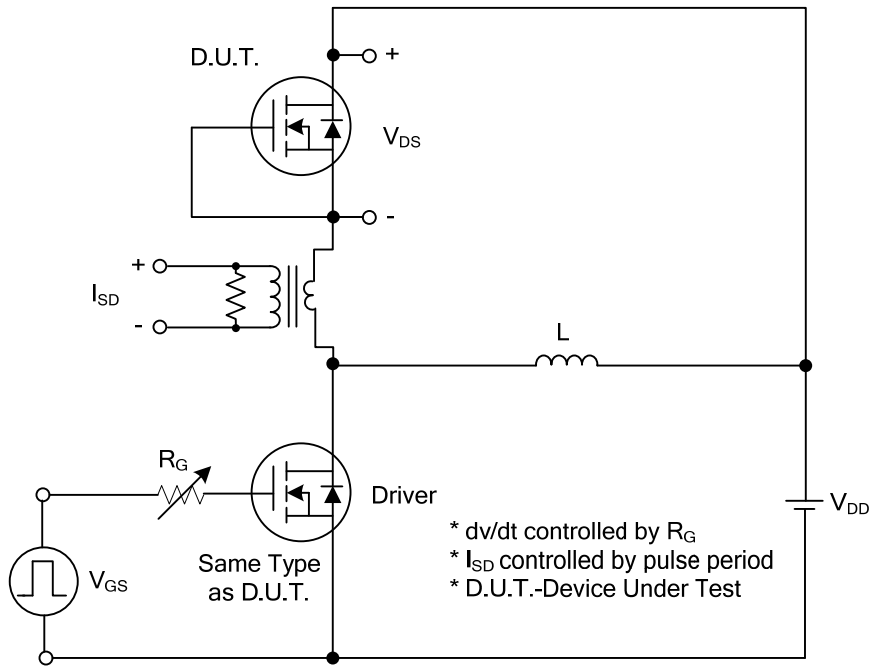
■ ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	1200			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=1200V, V_{GS}=0V$			10	μA
Gate-Source Leakage Current	Forward	$V_{GS}=+30V, V_{DS}=0V$			+100	nA
	Reverse		$V_{GS}=-30V, V_{DS}=0V$			-100
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=3.0A$			1.9	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0V, V_{DS}=50V, f=1.0MHz$		665		pF
Output Capacitance	C_{OSS}			40		pF
Reverse Transfer Capacitance	C_{RSS}			2.7		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{DS}=960V, V_{GS}=10V, I_D=6.0A$ (Note 1, 2)		29		nC
Gate to Source Charge	Q_{GS}			7.6		nC
Gate to Drain Charge	Q_{GD}			9		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=100V, V_{GS}=10V, I_D=6.0A,$ $R_G=25\Omega$ (Note 1, 2)		9		ns
Rise Time	t_R			18.5		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			80		ns
Fall-Time	t_F			40		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				6	A
Maximum Body-Diode Pulsed Current	I_{SM}				12	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=6.0A, V_{GS}=0V$			1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$I_S=6.0A, V_{GS}=0V,$ $di_F/dt=100A/\mu s$ (Note 1)		550		ns
Reverse Recovery Charge	Q_{rr}				7	

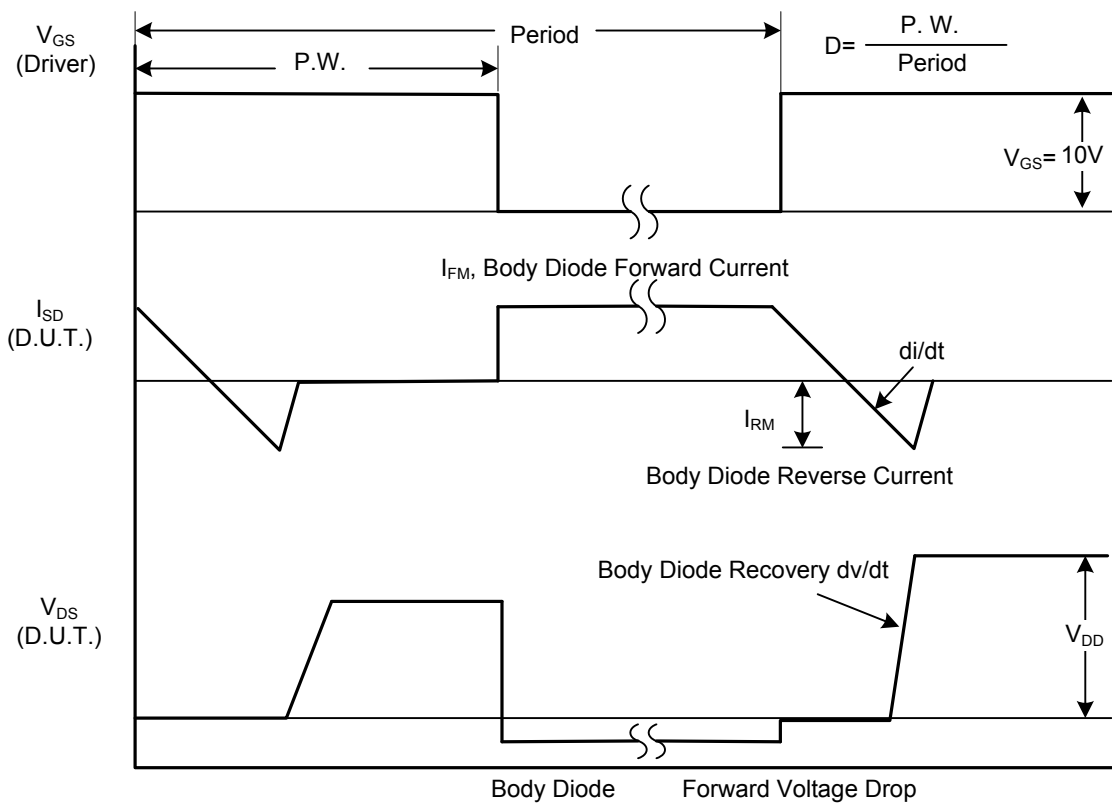
Notes: 1. Pulse Test: Pulse width $\leq 1200\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

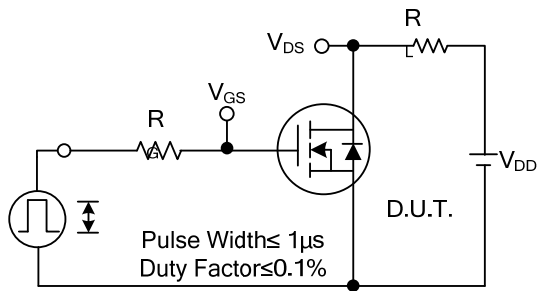


Peak Diode Recovery dv/dt Test Circuit

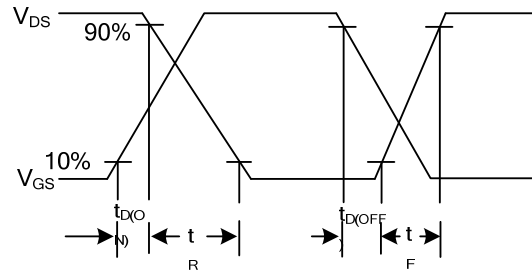


Peak Diode Recovery dv/dt Waveforms

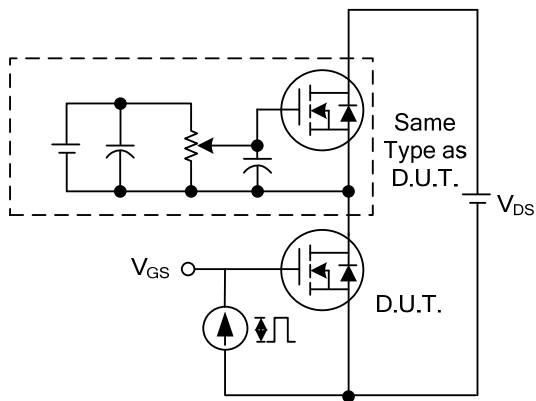
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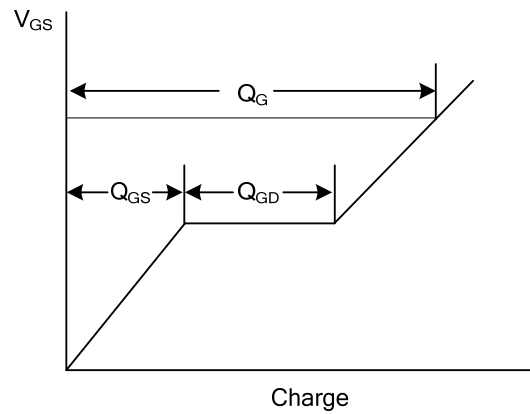
Switching Test Circuit



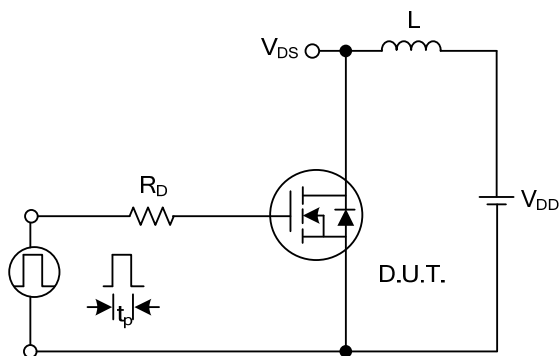
Switching Waveforms



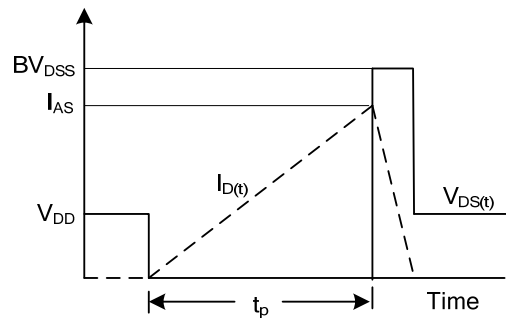
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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